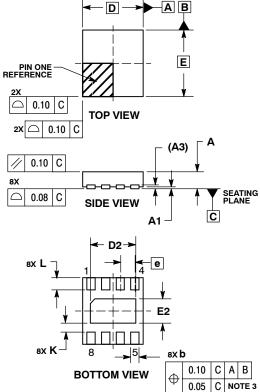


UDFN8 2x2.2, 0.5P CASE 506AV ISSUE C

DATE 26 JUN 2013





- NOTES:
 1. DIMENSIONING AND TOLERANCING PER
- ASME Y14.5M, 1994. CONTROLLING DIMENSION: MILLIMETERS.
- DIMENSION & APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.25 AND
- 0.30 mm FROM TERMINAL.

 COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

	MILLIMETERS		
DIM	MIN	NOM	MAX
Α	0.45	0.50	0.55
A1	0.00	0.03	0.05
А3	0.127 REF		
b	0.20	0.25	0.30
D	2.00 BSC		
D2	1.40	1.50	1.60
Е	2.20 BSC		
E2	0.70	0.80	0.90
е	0.50 BSC		
Κ	0.20		-
L	0.35	0.40	0.45

GENERIC MARKING DIAGRAM*



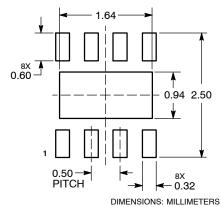
XX = Specific Device Code

= Date Code M

= Pb-Free Device

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present.

RECOMMENDED SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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98AON21873	3D

PAGE 2 OF 2

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